



### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	125	V
Collector-Emitter Voltage	V <sub>CEO</sub>	125	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Continuous Collector Current	Ic	1	A
Peak Pulse Current (Note 5)	I <sub>CM</sub>	3	A
Base Current	IB	500	mA

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	625	mW
Power Dissipation (Note 6)	PD	806	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	200	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>0JA</sub>	155	°C/W
Thermal Resistance, Junction to Leads (Note 7)	R <sub>θJL</sub>	194	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

## ESD Ratings (Note 8)

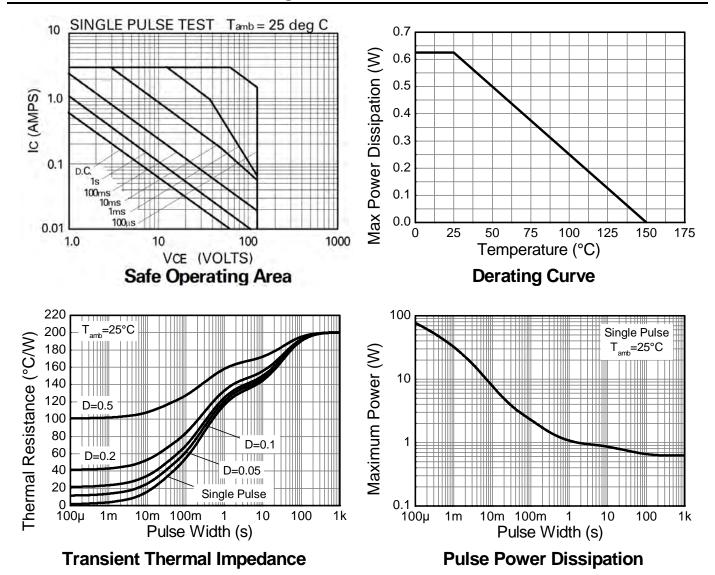
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	≥ 400	V	С

5. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured Notes: b) For a device surface modified on 25mm X 25mm PK4 PCB with high coverage of when operating in a steady-state condition.
c) Same as note 5, except the device is measured at t ≤ 5 sec.
c) Thermal resistance from junction to solder-point (at the end of the collector lead).
d) Refer to JEDEC specification JESD22-A114 and JESD22-A115.





## **Thermal Characteristics and Derating information**







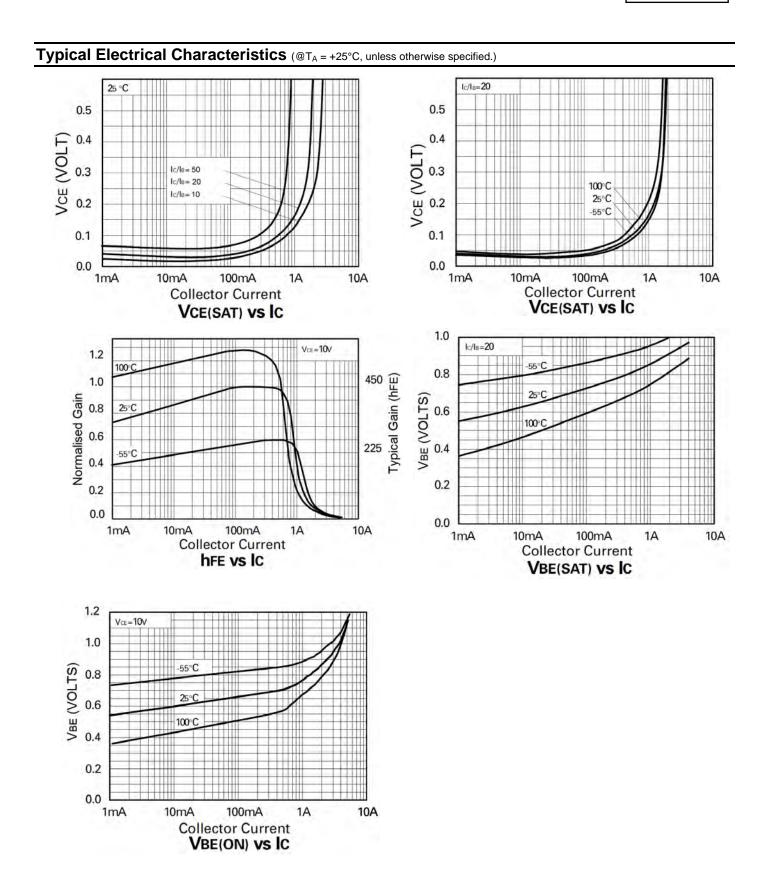
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	125	250	-	V	$I_{\rm C} = 100\mu A$
Collector-Emitter Breakdown Voltage (Note 9)	BV <sub>CEO</sub>	125	160	-	V	$I_{\rm C} = 1  \text{mA}$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.3	-	V	I <sub>E</sub> = 100μA
Collector Cut-off Current	I <sub>CBO</sub>	-	<10	100	nA	V <sub>CB</sub> = 100V
Emitter Cut-off Current	I <sub>EBO</sub>	-	<10	100	nA	V <sub>EB</sub> = 6.0V
Collector Emitter Cut-off Current	ICES	-	<10	100	nA	V <sub>CES</sub> = 100V
Static Forward Current Transfer Ratio (Note 9)	h <sub>FE</sub>	200 300 100	400 450 140 18	- - -	-	$\begin{split} I_{C} &= 10 \text{mA}, \ V_{CE} &= 10 \text{V} \\ I_{C} &= 200 \text{mA}, \ V_{CE} &= 10 \text{V} \\ I_{C} &= 1\text{A}, \ V_{CE} &= 10 \text{V} \\ I_{C} &= 3\text{A}, \ V_{CE} &= 10 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note 9)	V <sub>CE(sat)</sub>		26 70 160 165	50 150 220 250	mV	$\begin{split} I_{C} &= 0.1A, \ I_{B} = 10 \text{mA} \\ I_{C} &= 0.5A, \ I_{B} = 50 \text{mA} \\ I_{C} &= 0.5A, \ I_{B} = 10 \text{mA} \\ I_{C} &= 1A, \ I_{B} = 50 \text{mA} \end{split}$
Base-Emitter Saturation Voltage (Note 9)	V <sub>BE(sat)</sub>	-	0.85	1.0	V	$I_{\rm C} = 1$ A, $I_{\rm B} = 50$ mA
Base-Emitter Saturation Voltage (Note 9)	V <sub>BE(on)</sub>	-	0.70	1.0	V	$I_{C} = 1A, V_{CE} = 10V$
Transition Frequency	fT	100	155	-	MHz	$I_{C} = 50 \text{mA}, V_{CE} = 10 \text{V},$ f = 100MHz
Collector Output Capacitance	C <sub>obo</sub>	-	7	15	pF	$V_{CB} = 10V$ , f = 1MHz
Turn-On Time	t <sub>(on)</sub>	-	60	-	ns	$V_{CC} = 50V, I_C = 0.5A,$
Turn-Off Time	t <sub>(off)</sub>	-	1300	-	ns	$I_{B1} = -I_{B2} = 50 \text{mA}$

Notes: 9. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%





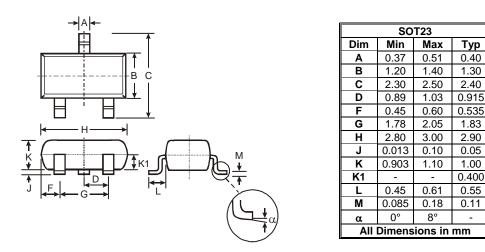






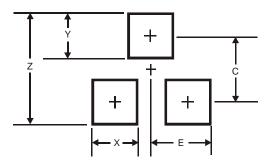
## **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35





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